

AMENDMENTS TO THE CLAIMS:

This listing of claims replaces all prior versions and listings of claims in the application:

LISTING OF CLAIMS:

1. (Currently Amended) A circuit arrangement for use with a mobile telephone, the circuit arrangement comprising:
a transmitting circuit comprising:
 - a first signal line that corresponds to a first frequency band;
 - a second signal line that corresponds to a second frequency band;
 - a switch that connects an antenna to one of the first and second signal lines;
 - a first amplifier in series with the first signal line;
 - a second amplifier in series with the second signal line;
 - a first band-pass filter between the first amplifier and the switch, the first band-pass filter having a frequency range that corresponds to the first frequency band; and
 - a second band-pass filter between the second amplifier and the switch, the second band-pass filter having a frequency range that corresponds to the second frequency band; and

a multi-layer ceramic module having integrated therein passive components for use in matching impedances between the switch and the first and second band-pass filters

a receiving circuit comprising:

~~a third signal line that corresponds to a third frequency band; and~~

~~a third band-pass filter in series with the third signal line;~~

~~wherein the third signal line comprises an only signal transmission line in the receiving circuit for passing signals from an external device.~~

2. (Currently Amended) The circuit arrangement of claim 22 +, ~~wherein the circuit arrangement further comprising:~~ comprises an isolator between the transmitting circuit and the receiving circuit.

3. (Cancelled)

4. (Currently Amended) The circuit arrangement of claim 1 3, further comprising sheet metal on which the first and second band-pass filters are mounted.

5 to 7. (Cancelled)

8. (Previously Presented) The circuit arrangement of claim 1, wherein the first and second band-pass filters have attenuation curves that can be brought into approximate alignment by shifting along a frequency axis.

9. (Previously Presented) The circuit arrangement of claim 1, wherein the first and second amplifiers have amplifications of less than 26 dB.

10. (Currently Amended) Circuitry comprising:
a transmitting portion; and
a receiving portion;
wherein the transmitting portion comprises plural signal lines, each of the plural signal lines for transmitting a signal in a different frequency band, each of the plural signal lines being in series with a switch, each of the plural signal lines comprising, in order, the a switch for connecting an antenna to one of the plural signal lines a signal line, a passive component for use in matching impedances between the switch and a band-pass filter, a the band-pass filter, an amplifier, and a surface acoustic wave filter;
wherein the transmitting portion comprises a multi-layer ceramic module having
the passive component integrated therein; and
wherein the receiving portion comprises a single signal line for receiving a signal from an external device, the single signal line comprising a passive component[[],] and a

~~band-pass filter, the single signal line comprising an only signal line in the receiving portion for passing signals from the external device.~~

11. (Previously Presented) The circuitry of claim 10, further comprising an isolator between the transmitting portion and the receiving portion.

12. (Cancelled)

13. (Currently Amended) The circuitry of claim 10, wherein the switch, and passive components of the transmitting portion and the receiving portion comprise part of a the multi-layer ceramic module.

14. (Previously Presented) The circuitry of claim 10, wherein the switch comprises at least one of a field effect transistor, diodes, and mechanical components.

15. (Currently Amended) The circuit arrangement of claim 22 4, wherein the first, second and third band-pass filters comprise surface acoustic wave filters.

16. (Currently Amended) The circuit arrangement of claim 23 2, wherein the first, second and third band-pass filters comprise surface acoustic wave filters.

17. (Cancelled)

18. (Currently Amended) The circuit arrangement of claim 22 4, wherein at least one of the first, second and third band-pass filters comprises a surface acoustic wave filter.

19. (New) The circuit arrangement of claim 1, wherein the switch is integrated in the multi-layer ceramic module.

20. (New) The circuit arrangement of claim 1, wherein the passive components comprise parts of a II filter.

21. (New) The circuit arrangement of claim 1, wherein the first and second band-pass filters comprise surface acoustic wave filters.

22. (New) The circuit arrangement of claim 1, further comprising:

a receiving circuit comprising:

a third signal line that corresponds to a third frequency band; and

a third band-pass filter in series with the third signal line.

23. (New) The circuit arrangement of claim 22, wherein the third signal line

comprises an only signal transmission line in the receiving circuit for passing signals from an external device.

24. (New) The circuit arrangement of claim 2, wherein the isolator comprises part of the multi-layer ceramic module.

25. (New) The circuit arrangement of claim 2, wherein the isolator comprises a circulator.